









Rev.	Count	Description of rev.	BY	CHKD	Date	Rev.	Count	Description of rev.	BY	CHKD	Date
0	-	Preliminary drawing	KYG	LHJ	221226		4	EC(RE-2-2376)	OSW	LHJ	230905
	1	Preliminary drawing(RE-2-2167)	KYG	LHJ	230306		-	EC(RE-2-2478)	KYG	LHJ	231208
	3	Released(RE-2-2337)	KYG	LHJ	230724						
Applicable standard		Universal Serial Bus Type-C Connectors and Cable Assemblies Compliance Document Revision 2.1b									
Rating	Voltage	48V AC/DC									
	Current	1.25A max. for each power pin (i.e., A1, A4, A9, A12, B1, B4, B5, B9, B12) 0.25A max. for the others.									
Operating condition		-40°C~+105°C(Including temp. rise), 95% R.H. max.(Non-condensing)									
Storage condition		-10°C~+60°C(With packing), 15%~70% R.H.									

SPECIFICATIONS					
No	TEST ITEM	TEST METHOD	TEST REQUIREMENT	QT	AT
CONSTRUCTION					
1	General examination	EIA 364-18 Visual inspection	No physical damage	O	O
ELECTRICAL CHARACTERISTICS					
2	Low level contact resistance	EIA 364-23 Measure at 20mV max open circuit at 100mA max. (DC or 1000Hz) 4-wire measurement is required and the resistance of PCB termination shall be deducted from the reading.	Initial : 40mΩ max After test : 50mΩ max	O	-
3	Dielectric withstanding voltage	EIA 364-20, Method B Measure with unmated condition. 100V AC RMS for 1 minute at sea level.	No disruptive discharge.	O	-
4	Insulation resistance	EIA 364-21 500V DC with unmated and mated condition.	100MΩ min	O	-
5	Temperature rise	EIA 364-70, Method B A current of 5.0 A shall be applied collectively to Vbus pins (i.e., pins A4, A9, B4, and B9) and 1.25 A applied to the Vconn pin (i.e., B5 of the plug connector) with the return path through the corresponding GND pins (i.e., pins A1, A12, B1, and B12). A minimum current of 0.25 A shall also be applied individually to all the other contacts.	Temperature rise shall not exceed 30°C above the ambient temperature.	O	-

No	TEST ITEM	TEST METHOD	TEST REQUIREMENT	QT	AT
MECHANICAL CHARACTERISTICS					
6	Insertion force	EIA 364-13 Measure at 12.5mm/minute min.	Initial & after test : 5N~20N	O	-
7	Extraction force	EIA 364-13 Measure at 12.5mm/minute min.	Initial : 8N~20N After test : 6N~20N (with virgin plug)	O	-
8	Durability	EIA 364-09 Mated 10,000 times Mechanically operated : 500±50cycles/hr Mating stroke : 2.75mm Insertion, extraction force shall be measured at a maximum speed of 12.5mm/min	No physical damage.	O	-

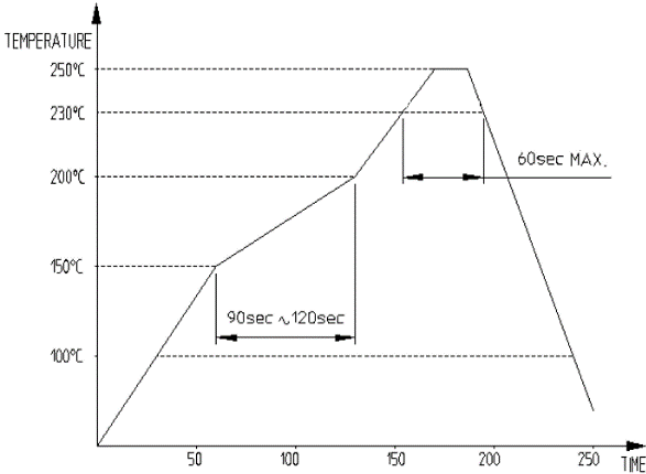
Remarks	Drawn	Designed	Checked	Approved	Release
	Y.G.KIM 22.12.26	Y.G.KIM 22.12.26	Y.B.PARK 22.12.26	H.J.LEE 22.12.26	
[Note.] QT : Qualification test, AT : Assurance test, O : Applicable, - : Not applicable					
Drawing No. ELC4-633754-00		CL No. CL ****-****-*----		Part No. CX90MW9-24P*	
 HIROSE KOERA.CO.,LTD			PRODUCT SPECIFICATION		1 / 5

ENVIRONMENTAL CHARACTERISTICS					
9	Random vibration	EIA 364-28 Test condition VII, Test condition letter D Grms : 3.10g Frequency : 20~500Hz 15 minutes in each of 3 mutually perpendicular planes.	No physical damage. No discontinuity of over than 1 μ s.	O	-
10	Temperature life	EIA 364-17, Method A 105°C without applied voltage for 120 hours.	No physical damage.	O	-
11	Cyclic temperature and humidity	EIA 364-31 25 \pm 3°C/80 \pm 3% R.H. for 1 hour. 65 \pm 3°C/50 \pm 3% R.H. for 1 hour. Ramp time : 0.5 hour Number of cycles : 24 cycles	No physical damage.	O	-
12	Thermal shock	EIA 364-32 10 cycles -55°C and +105°C	No physical damage.	O	-
13	Solderability	EIA 364-52 Dwell in 245 \pm 5°C of the solder bath for 5 sec.	Solder coverage shall be 95% min. of the immersed surfaces.	O	-
14	Salt spray	EIA 364-26 5% of NaCl in 35°C for 48 hours. Test with soldered condition on the PCB.	No corrosions that affect to the connector operation.	O	-
15	High temperature and humidity	EIA-364-31 High-temperature 85°C/85% R.H. for 120 hours.	No physical damage. No change to performance.	O	-
16	Mixed flowing gas	EIA 364-65 Measure Environment 30°C/70% R.H. Cl ₂ 10 \pm 3ppb, NO ₂ 200 \pm 50ppb, H ₂ S 10 \pm 5ppb, SO ₂ 100 \pm 20ppb Expose half of sample mated for 1/3 days and then unmated for 2/3 days .The others are exposed mated for full 7 days test period.	No corrosions that affect to the connector operation.	O	-
17	 Water resistance	Conduct the IP code test according to the corresponding P/N as shown as Table.1 ① IPX4 IEC60529 No matter which direction the water splashes on the enclosure, it must be waterproof. Duration : 10minutes at least. Water volume : 10L/min Pressure : 50~150kPa ② IPX8 IEC60529 Immersion in the water at the depth of 1.5m for 30min	No water leakage to cause functional problems.	O	-

[Note] QT : Qualification test, AT : Assurance test, O : Applicable, - : Not applicable					
Drawing No. ELC4-633754-00		CL No. CL ****-****-*----		Part No. CX90MW9-24P*	
 HIROSE KOERA.CO.,LTD			PRODUCT SPECIFICATION		2 / 5

18	<div><div><div>3</div></div></div> <div>Dust resistance</div>	<div>Conduct the IP code test according to the corresponding P/N as shown as Table.1</div> <div>① IP5X</div> <div>IEC60529</div> <div>Duration : 8hours at least.</div> <div>Amount of talcum powder of the test chamber : 2kg/m³</div> <div>Dust type : Talcum Powder (less than 75μm)</div> <div>② IP6X</div> <div>IEC60529</div> <div>Duration : 8hours at least.</div> <div>Amount of talcum powder of the test chamber : 2kg/m³</div> <div>Dust type : Talcum Powder (less than 75μm)</div> <div>Depression : 2kPa max</div>	<div>No ingress of dust to cause functional problems.</div>	O	-
19	Reflow heat	<div>Reflow profile Fig.1</div> <div>Peak 250°C max for 2 times.</div>	<div>No deformation of mold.</div> <div>No shape of blister and popcorn.</div>	O	-




REMARKS



[Fig.1] REFLOW TEMPERATURE


[Note.] QT : Qualification test, AT : Assurance test, O : Applicable, - : Not applicable			
Drawing No.	CL No.	Part No.	
ELC4-633754-00	CL ****-****-*----	CX90MW9-24P*	
HRS HIROSE KOERA.CO.,LTD		PRODUCT SPECIFICATION	3 / 5

 Test Sequence Table


No	Test item	Test Group										
		A	B	C	D	E	F	G	H	I	J	K
1	General examination	1, 7	1, 15	1, 7	1, 7	1, 7	1, 3	1, 7	1, 7	1, 7	1, 4	1, 9
2	Low level contact resistance	3, 6	3, 14	3, 6	3, 6	3, 6		3, 6	3, 6	3, 6		3, 8
3	Dielectric withstanding voltage		4, 12									
4	Insulation resistance		5, 11									
5	Temperature rise										3	
6	Insertion force		6, 10									
7	Extraction force		7, 9									
8	Durability		8									4
9	Random vibration	4										
10	Temperature life			4								
11	Cyclic temperature and humidity				4							
12	Thermal shock					4						5
13	Solderability						2					
14	Salt spray							4				
15	High temperature and humidity								4			6
16	Mixed flowing gas									4		
17	  Water resistance	5	13	5	5	5		5	5	5		
18	 Dust resistance											7
19	Reflow heat	2	2	2	2	2		2	2	2	2	2


REMARKS


1) Numbers in the table above indicate the sequence corresponding to each test group.

[Note.] QT : Qualification test, AT : Assurance test, O : Applicable, - : Not applicable			
Drawing No.	CL No.	Part No.	
ELC4-633754-00	CL ****-****-*----	CX90MW9-24P*	
 HIROSE KOERA.CO.,LTD		PRODUCT SPECIFICATION	<div>45</div>

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[Table. 1] CX90MW9-24P* Series P/N List 

No.	P/N	Code No.	 IP Code
1	CX90MW9-24P	CL 6249-0010-7-000	IP54
2	CX90MW9-24P1	CL 6249-0012-2-000	IP68

[Note.] QT : Qualification test, AT : Assurance test, O : Applicable, - : Not applicable			
Drawing No.	CL No.	Part No.	
ELC4-633754-00	CL ****-****-*----	CX90MW9-24P*	
 HIROSE KOERA.CO.,LTD		PRODUCT SPECIFICATION	<div>55</div>